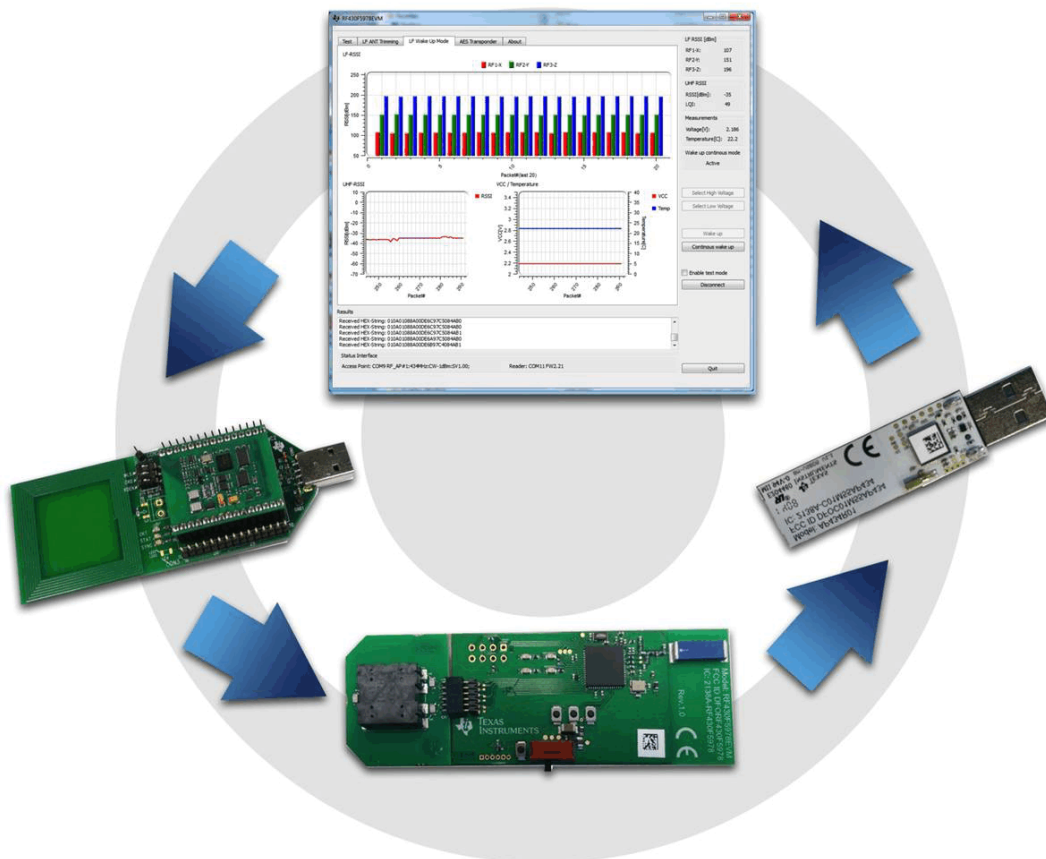


RF430F5978EVM User Guide

This manual describes the software installation, driver installation, the modules and peripherals of RF430F5978EVM. Each description presents the module or peripheral in a general sense. Not all features and functions of all modules or peripherals may be present on all devices. In addition, modules or peripherals may differ in their exact implementation between device families, or may not be fully implemented on an individual device or device family.

Pin functions, internal signal connections, and operational parameters differ from device to device. The user should consult the device-specific data sheet for these details.



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1 Overview

To get started evaluating the RF430F5978 MCU, system developers can purchase the RF430F5978EVM bundle. This bundle helps users evaluate the key features of RF430F5978 MCU: 3D LF wake-up and trigger function, passive battery-less transponder operation, and resonant trimming.

The bundle includes a USB plug-in LF trigger module (MRD2EVM micro reader), RF430F5978 MCU evaluation board (RF430F5978EVM), AP434R01 access point, and 3D LF antenna. Using this EVM bundle, a typical demo application can be set up in which the RF430F5978 captures data from multiple sensors over a period of time and, after it is triggered by the LF wake-up trigger from the reader, it transmits the collected data to the access point via RF link. This data is then sent on to the included host GUI to visualize the data curve and position of the object.

Features and benefits of the RF430F5978 MCU:

- Reduces power consumption by allowing the shutdown of the RF radio and quick startup with the LF wake-up function, thus significantly extending battery life.
- Tracks its position and distance (within ± 5 cm) relative to the 3D LF transponder using RSSI (return signal strength indicator) within a 4-m radius of the reader's LF trigger.
- Protects sensitive data and prevents signal interference with the AES security coprocessor that allows data encryption for product authentication and secure access control.
- Provides flexible customization at ultra-low power with the programmable MSP430 core.
- Accommodates a wide range of regional Sub-1GHz frequencies from 300 to 950 MHz.
- Reduces board size and cost with the integration of several key functions into a single MCU.
- Works with complementary TI components, such as TPS62163 and TPS62082 power management ICs, the SimpleLink™ Wi-Fi® CC3100, and bq24040 IC.

2 Related Documentation from Texas Instruments

The primary sources of RF430 information are the device-specific data sheets and user's guides. The most current information is found at the following links:

www.ti.com/product/RF430F5978

www.ti.com/msp430

www.ti.com/product/cc1101

www.ti.com/tool/RF430F5978EVM

www.ti.com/tool/smartrfm-studio

3 RF430F5978 Demo Kit Overview

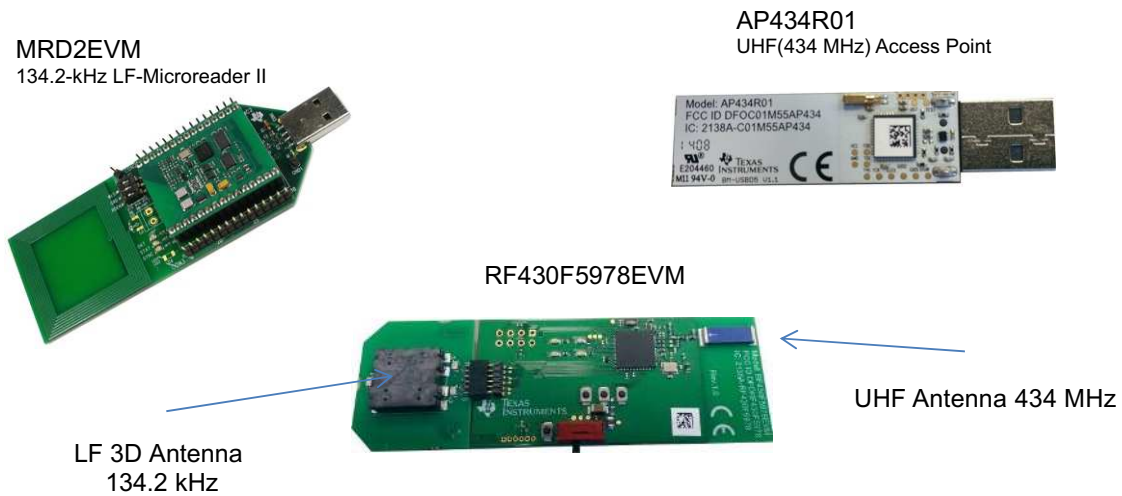


Figure 1. RF430F5978EVM Kit

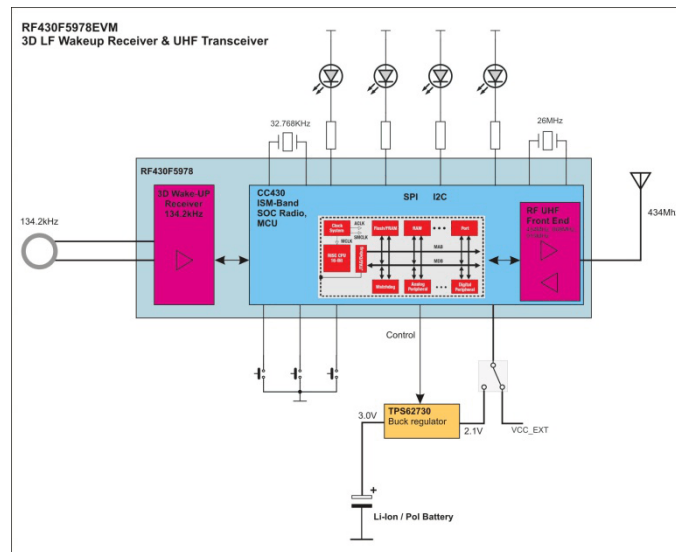


Figure 2. RF430F5978EVM Block Diagram

4 Introduction

The RF430F5978EVM, including the [user software](#), is a complete evaluation platform to evaluate the key features of RF430F5978:

- 3D LF long-range trigger and wake-up function
- Passive batteryless transponder communication
- Resonant trimming

In a typical sequence, the MRD2EVM LF transmitter sends a 64-bit wake pattern and, as soon as the RF430F5978EVM board is within the supply range (typically 2 m with the components in this kit but can reach up to 10 m with an LF power transmitter) and detects a valid wake pattern, then activates the microcontroller. The microcontroller then measures the receive signal strength (RSSI) of all three axes on the 3D LF antenna, interprets the orientation and distance of the device, measures the temperature, battery, and system voltage, and sends the information through the onboard UHF transceiver to the AP434R01 access point.

The returned data is visualized by the user software GUI, which shows the signal strength on all three axes, the temperature, and the supply voltage logging data (see [Table 1](#) and [Figure 3](#)).

Table 1. GUI Tabs

Tab	Name	Contents and Functions
1	LF Wake Up Mode	Demonstrate LF Wake Up Mode with UHF response
2	LF ANT Trimming	LF Antenna Trimming function
3	Test	Hardware Function test
4	AES Transponder	AES Transponder function User Terminal
5	About	Software version and User Guide of RF430F5978EVM

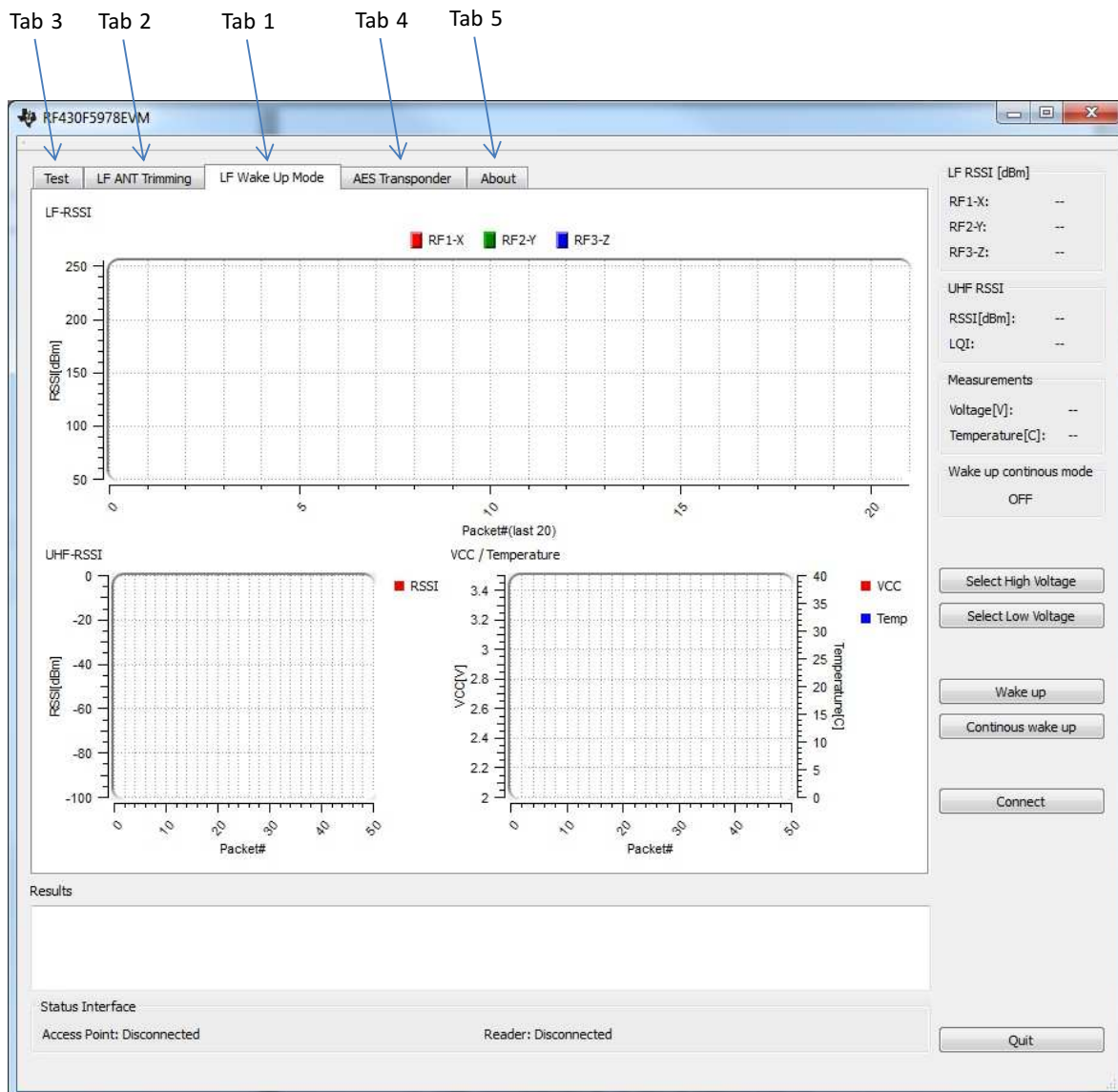


Figure 3. RF430F5978EVM GUI

5 Kit Contents

- MRD2EVM module
- RF430F5978EVM module
- AP434R01 module
- JTAG-SBW adapter module
- RF430F5978EVM quick start guide
- 1.27 4-pin connector



Figure 4. RF430F5978EVM Package

For complete ordering information, see the TI web site at www.ti.com/tool/RF430F5978EVM.

6 Required Equipment

The following equipment is required to operate the RF430F5978EVM:

- A PC running the Windows 7 operating system
- A lithium coin battery: 3 V, 20 mm, CR2032
 - **Note:** Use only Panasonic CR2032 lithium battery or equivalent
 - Battery requirements: CR2032 UL recognized component battery
Voltage: 3 V, Capacity: 230 mAh (typical data sheet numbers), Minimum Capacity (for 1 hour operation): 5 mAh

7 Software, Driver, and Documentation

The latest software, driver, and user guide are available at www.ti.com/tool/RF430F5978EVM.

1. Download the RF430F5978EVM.EXE installer file to the PC.
2. The installer file includes software, driver, and user guide.
3. Double-click the installer file to install the software package and drivers.

The default installation location for the demo software is C:\Program Files\RF430F5978EVM.

8 Set Up RF430F5978EVM Demo

The following steps set up the hardware and software to run the default demo:

1. Insert the CR2032 battery in the RF430F5978EVM module as shown in [Figure 5](#).

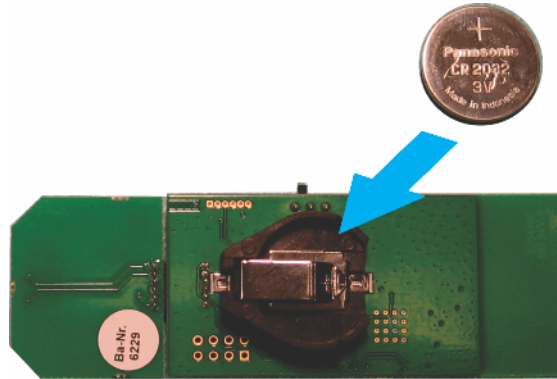


Figure 5. RF430F5978EVM Battery Assembly

2. Connect MRD2 reader and the AP434R01 access point to USB interfaces on the PC (see [Figure 6](#)).

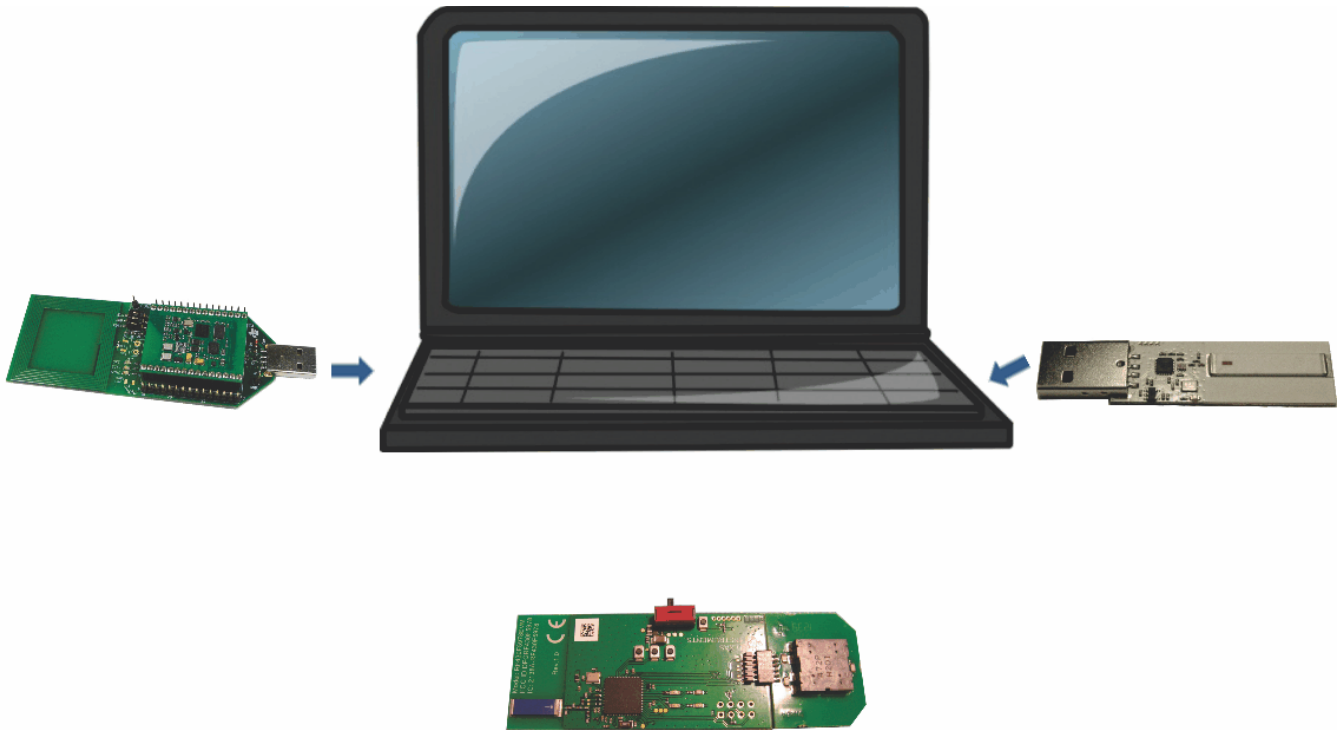


Figure 6. RF430F5978EVM USB Connection

3. Install the LF-Microreader (MRD II) driver, the 'Microreader II Virtual COM Port' driver.
 The operating system should automatically detect the COM port driver for the LF-Microreader. If you are prompted for the driver, the default installation location is C:\Program Files (x86)\RF430F5978EVM\Driver.
 Driver INF file: MicroreaderII.inf
 Follow the instructions of the operating system to install the driver.
4. Install the AP434R01 UHF access point driver, the 'AP434R01 Virtual COM Port' driver.
 The operating system should automatically detect the COM port driver for the AP434R01. If you are prompted for the driver, the default installation location is C:\Program Files (x86)\RF430F5978EVM\Driver.
 Driver INF file: RF_AP.inf
 Follow the instructions of the operating system to install the driver.
5. Set the power switch on the RF430F5978EVM module to the battery mode (left position) (see [Figure 7](#)).

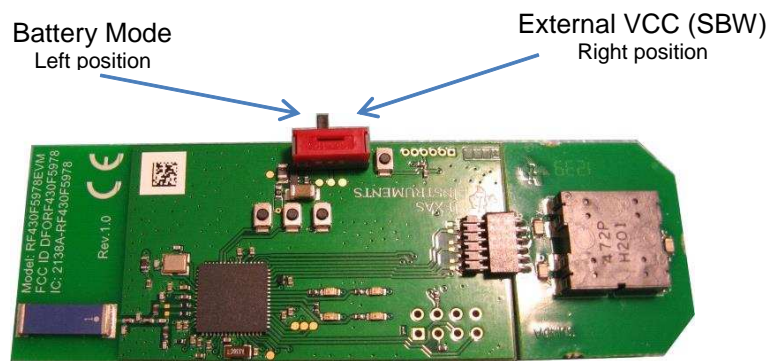


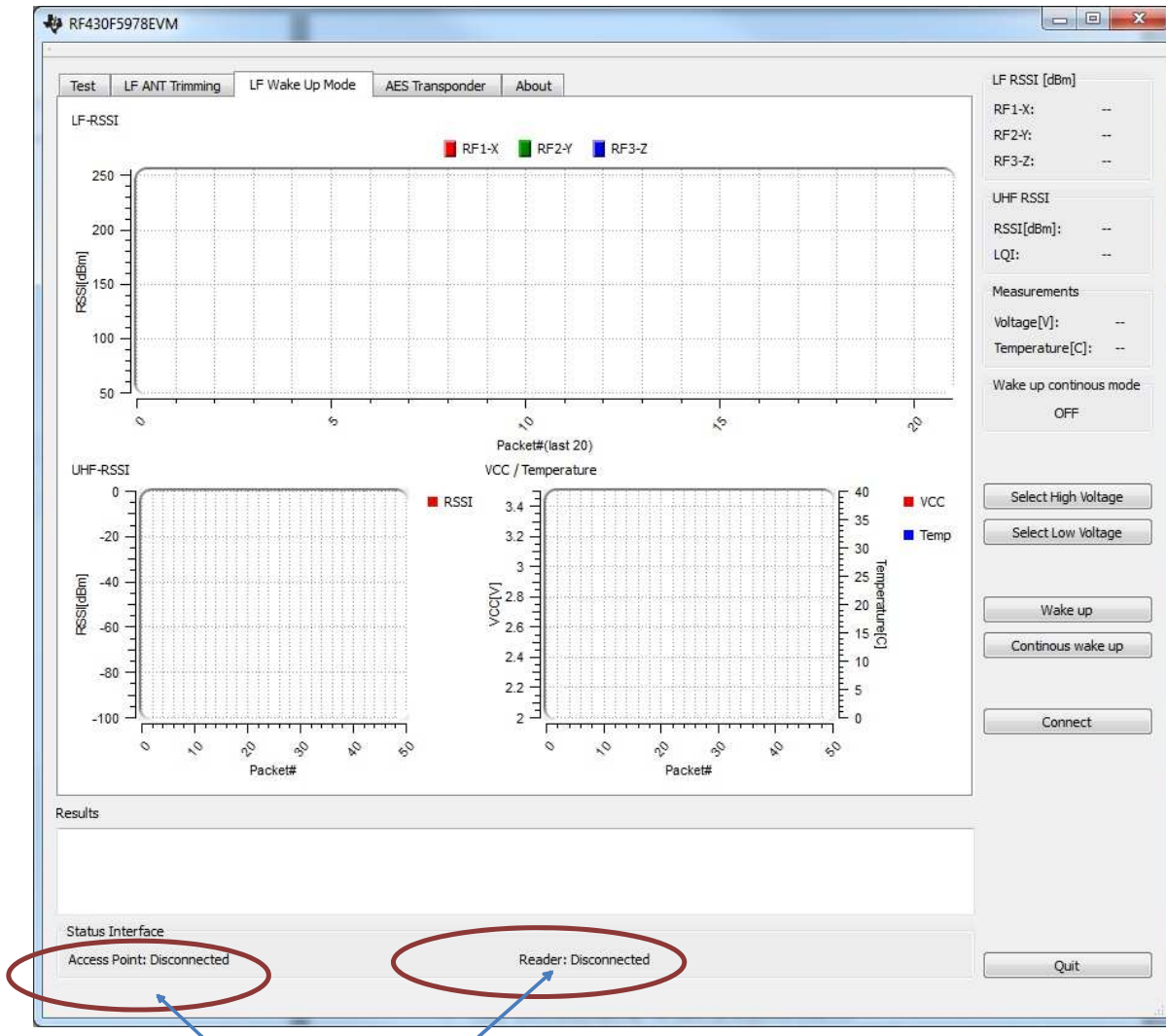
Figure 7. RF430F5978EVM Power Switch

The hardware is now ready to start the demo.

9 Start the Software

To run the software, click Start → All Programs → RF430F5978EVM → RF430F5978EVM. The LF reader and UHF access point will be automatically detected.

1. Start the software RF430F5978EVM.
2. Click "Connect".
3. Check if the Microreader and USB access point are available (see [Figure 8](#)).

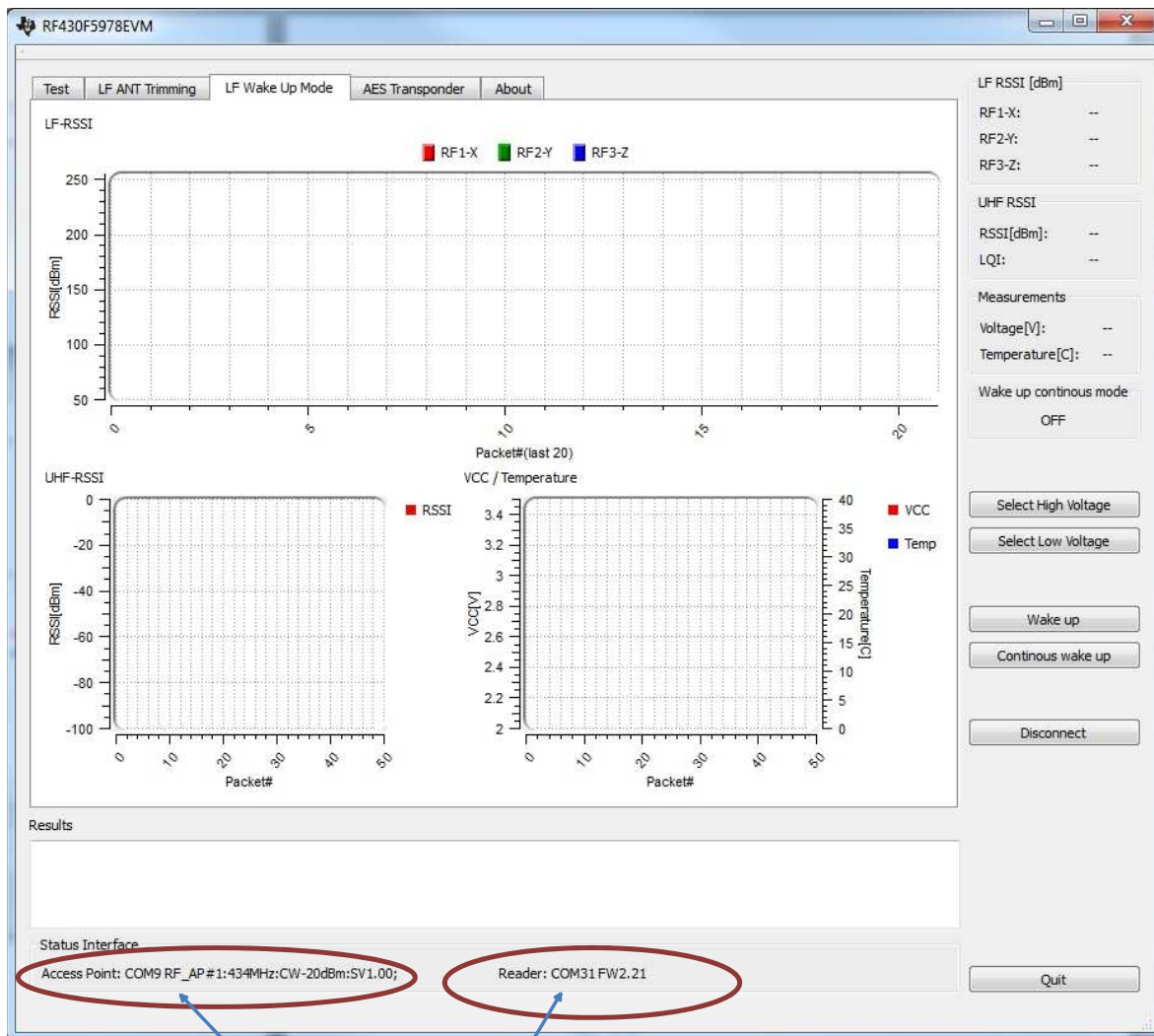


Access point and MRD2 not available

Figure 8. RF430F5978EVM GUI Hardware Status 1

4. If MDR2 and USB Access point not available, ensure that the MRD2 and AP434R01 access point are connected to the PC, and then click "Connect" again.

5. Check if the Microreader and USB access point are available (see Figure 9).



Access point and MRD2 is now available

Figure 9. RF430F5978EVM GUI Hardware Status 2

6. If both are available, the software is ready to start the demo.

10 Using the LF Wake-Up Mode With UHF Response

The following steps show how to enable complete (bidirectional) LF communication, which means that the MRD2 can send an LF wake pattern and can then receive the UHF response of the RF430F5978EVM module that receives the wake-up signal (see [Figure 10](#)).

1. Click "Wake up" button to start the wake-up sequence one time.
2. Click "Continuous wake up" to initiate continuous mode (approximately 2-s cycle time)
3. Click "Continuous wake up" again to stop the continuous mode.

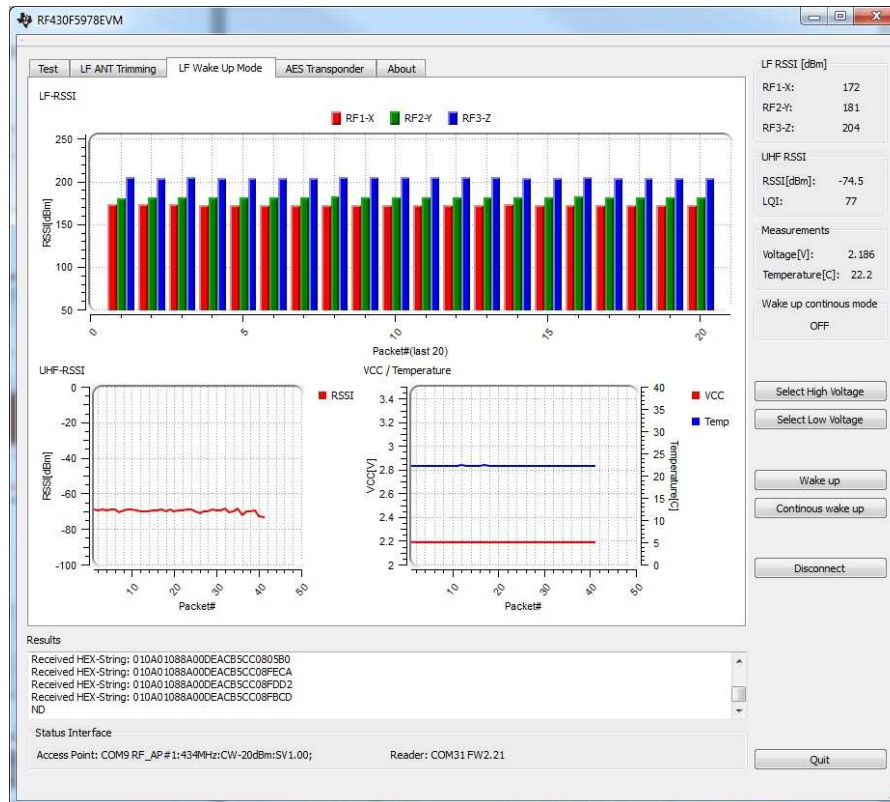


Figure 10. RF430F5978EVM Wakeup Mode Demo 1

11 LF Wake-Up Mode Tab

Figure 11 shows the LF Wake Up Mode tab. Refer to the following description for more details.

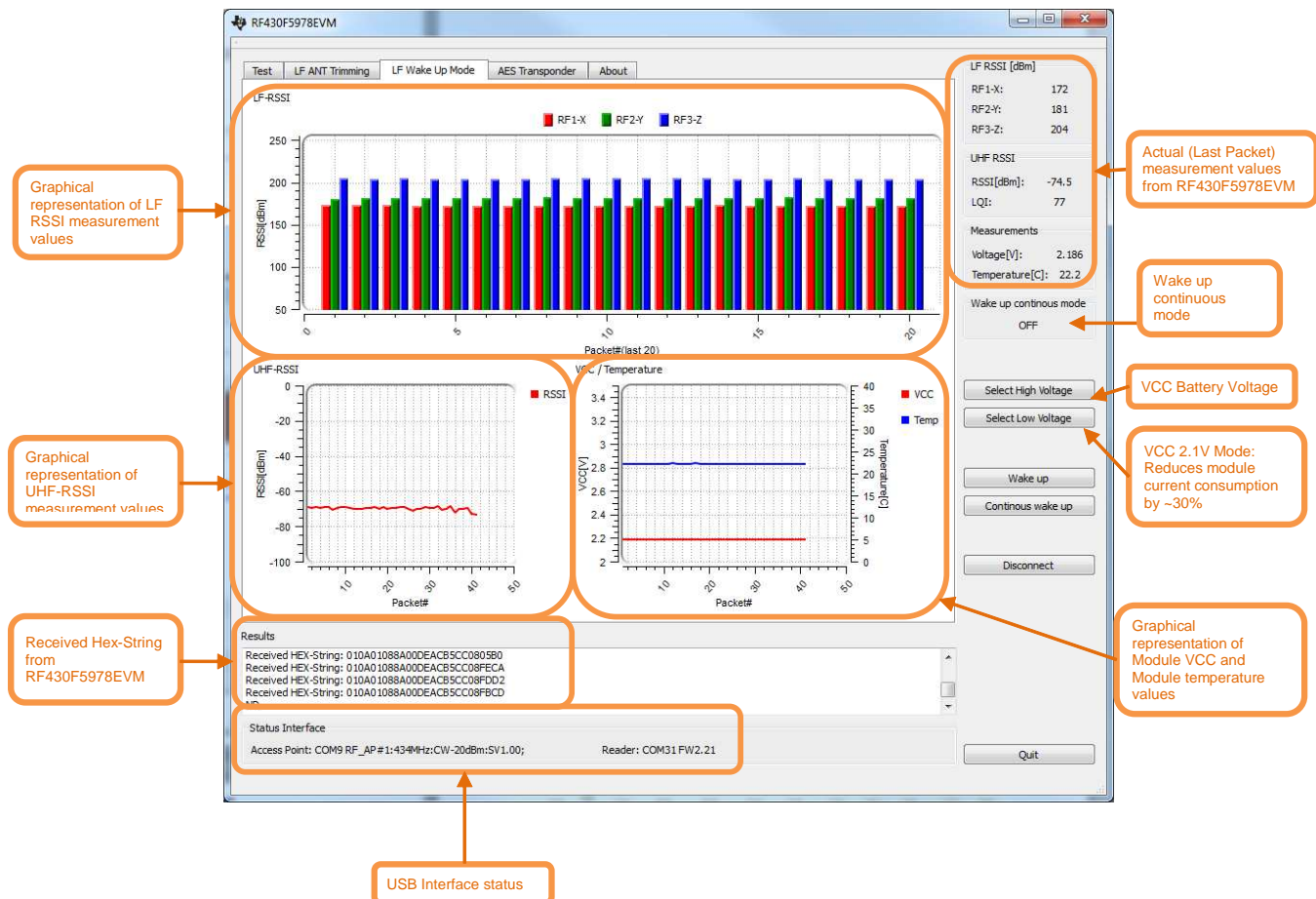


Figure 11. RF430F5978EVM Wakeup Mode Demo 2

- 1. LF RSSI bars** displays the different RSSI (received signal strength indicator) values of the 3D antenna (red for x, green for y, blue for z). The max value is 255 dBm. The RSSI value of each RF430F5978 antenna axis depends on the RF430F5978 module position and orientation relative to the LF trigger (MRD2). Continuous mode displays the last 20 packets.
- 2. UHF RSSI scatter xy graph** displays the RSSI value of the received UHF (434 MHz) signal. Continuous mode displays the last 50 packets.

3. Received data on UHF antenna at wake up mode. If no data is available, reports "ND".

Table 2. Received Data Examples

Content	Start	Length	Command	Voltage (mV)	Temperature (°C)	LF RSSI X (dBm)	LF RSSI Y (dBm)	LF RSSI Z (dBm)	LF Wake	UHF RSSI ⁽¹⁾	UHF LQI ⁽²⁾	EOL
Example:	01	0A	01	087E	00EA	A3	AD	CA	08	24	B0	0D
Explanation:	Start of Telegram	Without (start, length, Cmd and EOL) byte	Response always Null Byte	Representing voltage 0x087E ⇒ 2174 mV	Representing temperature 0x00EA ⇒ 23.4°C	Representing LF RSSI X 0xA3 ⇒ 163 dBm	Representing LF RSSI Y 0xAD ⇒ 173 dBm	Representing LF RSSI Z 0xCA ⇒ 202 dBm	Which wake up occurred 8 ⇒ Wake A	Representing UHF RSSI 0x24 ⇒ -54 dBm	Representing UHF LQI EST 0xB0 & 0x7F ⇒ 48	EOL End of Message
	1 byte	1 byte	1 byte	2 byte	2 byte	1 byte	1 byte	1 byte	1 byte	1 byte	1 byte	1 byte

(1) UHF RSSI

The UHF RSSI value read from the RSSI status register is a 2s-complement number. The following procedure can be used to convert the RSSI reading to an absolute power level (RSSI_dBm)

1. Read the RSSI status register
2. Convert the reading from a hexadecimal number to a decimal number (RSSI_dec)
3. If $RSSI_dec \geq 128$ then $RSSI_dBm = (RSSI_dec - 256)/2 - RSSI_offset$
4. If $RSSI_dec < 128$ then $RSSI_dBm = (RSSI_dec)/2 - RSSI_offset$

Refer to the device-specific data sheet for typical RSSI offset values and for typical RSSI values vs input power levels at various frequencies.

The RF430F5978EVM power condition meets following regulations:

FCC 5.231
ETSSI 300 220
ETSSI 300 330
ETSSI 301 489

(2) Link Quality Indicator (LQI)

The Link Quality Indicator is a metric of the current quality of the received signal. If PKTCTRL1.APPEND_STATUS is enabled, the value is automatically added to the last byte appended after the payload. The value can also be read from the LQI status register. The LQI gives an estimate of how easily a received signal can be demodulated by accumulating the magnitude of the error between ideal constellations and the received signal over the 64 symbols immediately following the sync word. LQI is best used as a relative measurement of the link quality (a low value indicates a better link than what a high value does), because the value is dependent on the modulation format. (Mask out bit7, as $LQI = \text{bit6 to bit0}$)

4. USB Interface status displays the status of USB connection Access point and MRD2.

- Access Point:
 - Virtual com port, module serial number, frequency band, CW PA, firmware version
 - Not found: No access point available
- Reader (MRD2) :
 - Virtual com port, firmware version
 - Not found: No Micro Reader 2 available

5. Temperature and VCC graphical display

- The red line represents RF430F5978EVM VCC module voltage.
- The green line represents RF430F5978EVM module temperature.
Continuous mode displays the last 50 packets.

12 LF Antenna Trimming Tab

Figure 12 shows the LF Antenna Trimming Tab. Refer to the following description for more details.

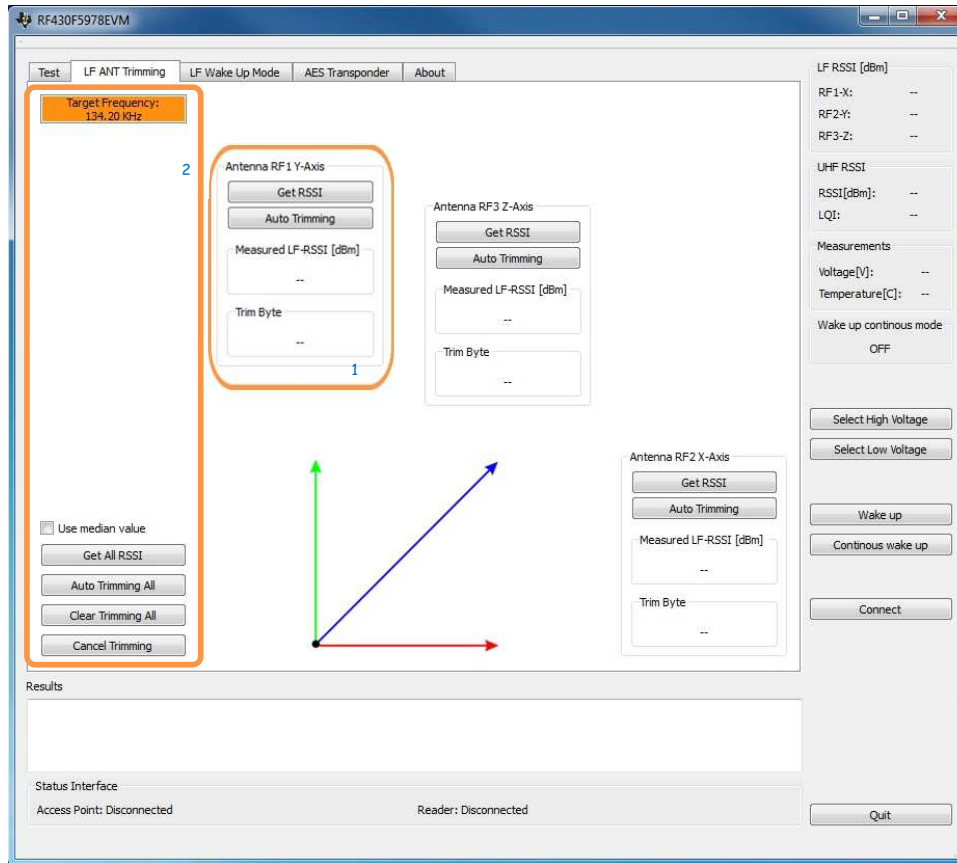


Figure 12. RF430F5978EVM LF Antenna Trimming Tab

1. Antenna RFx (x)-Axis

- Get RSSI: Measure LF-RSSI of separate 3D Antennas
- Auto Trimming: Internal cap trimming for separate 3D Antennas
- Measured LF-RSSI: Measured LF-RSSI at MRD2
- Trim Byte: Display the trim byte

2. General Trimming function

- Target Frequency is at 134.2 kHz
- Checkbox "Use median value": The median value build out of 3 measurement values. The trimming is more accurate but the process needs more time.
- Get All RSSI: Measure all LF-RSSI values.
- Auto Trimming All: Internal cap trimming for all 3D Antennas
- Clear Trimming All: Clear all Trimming settings
- Cancel Trimming: Stop Trimming process

13 Test Tab

Figure 13 shows the hardware Test tab. Refer to the following description for more details.

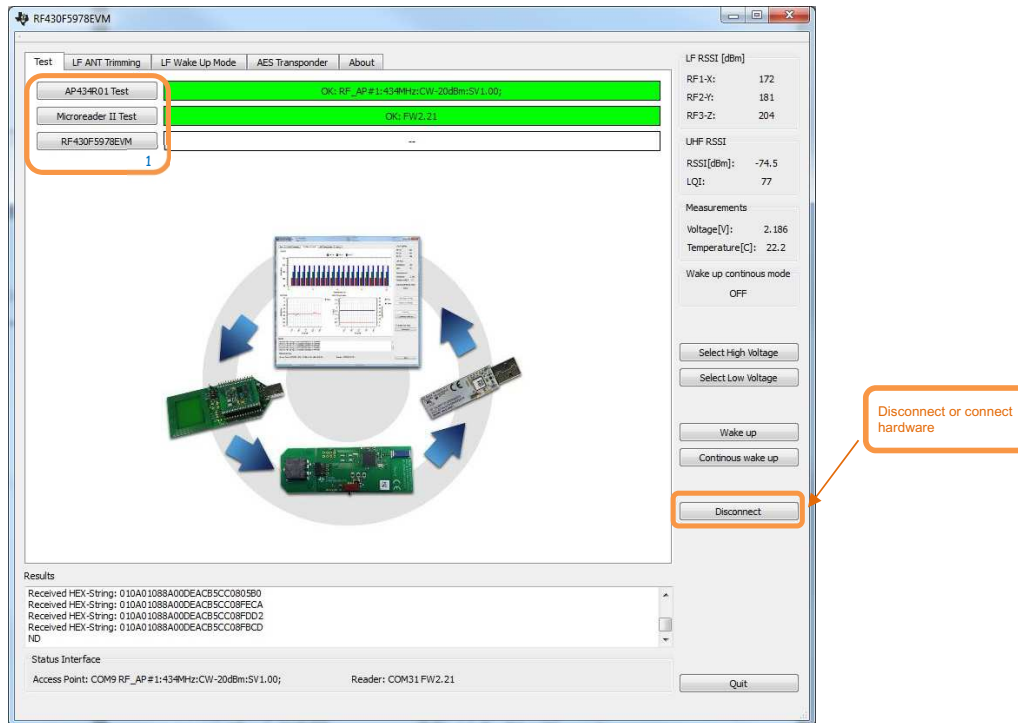


Figure 13. RF430F5978EVM Hardware Test Tab

AP434R01 Test

Hardware test "Access point"

Status Display:

Green indicates that the status of the USB connection to the access point is OK. The virtual COM port, module serial number, frequency band, CW PA, and firmware version are reported.

Red indicates that no access point is available. Check the USB connection.

Microreader II Test

Hardware test "MRD2"

Status Display:

Green indicates that the status of the USB connection to the MRD2 is OK. The virtual COM port and firmware version are reported.

Red indicates that no MRD2 module is available. Check the USB connection.

RF430F5978EVM

Hardware test "RF430F5978EVM"

Status Display:

Green indicates that RF430F5978EVM LF and UHF communication are OK. The module name, serial number, and firmware version are reported.

Red indicates that communication with the RF430F5978EVM module is not possible.

Possible errors:

- No Battery
- Power Switch not in Battery mode
- 3D Antenna not connected

14 AES Transponder User Interface

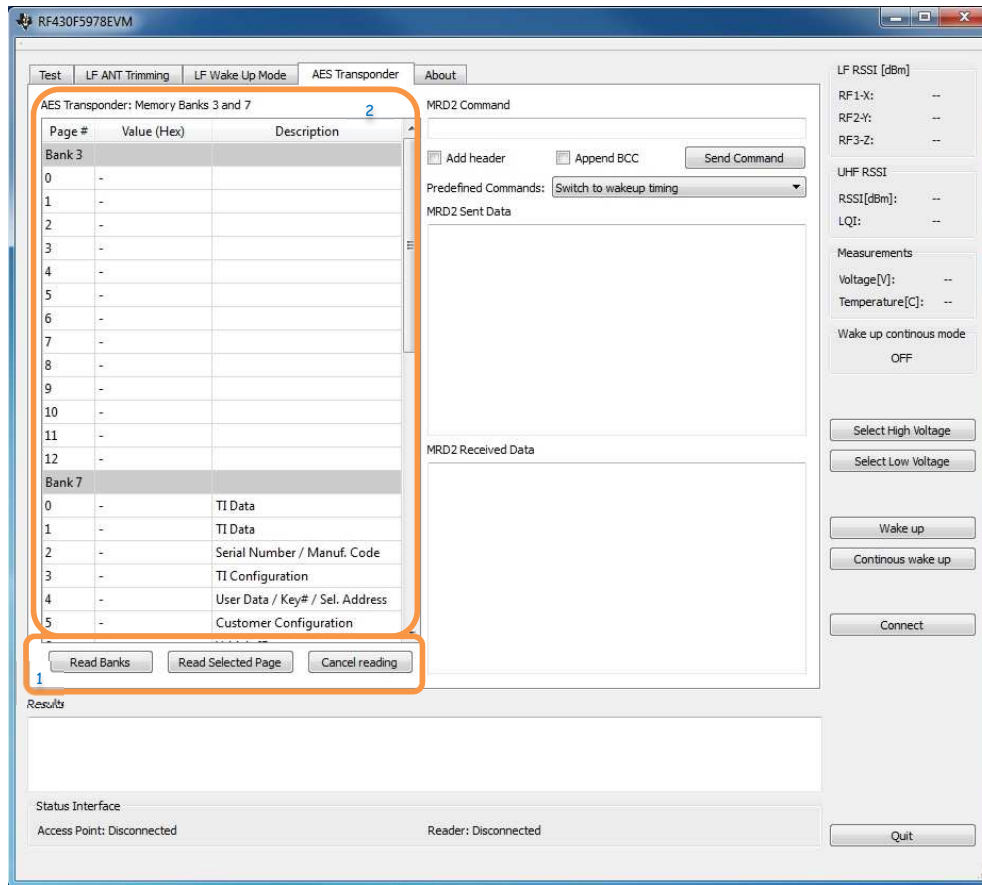


Figure 14. RF430F5978EVM AES Transponder Tab 1

1. Transponder Bank 3/7 and Pages:

Read Banks: Read out complete Bank 3 and Bank 7 Pages from RF430F5978EVM module

Read Selected Page: Read out the selected page from RF430F5978EVM module

Cancel reading: Cancel the read operation

2. Transponder Bank 3/7 and Pages table:

Display the bank 3/7 and pages results

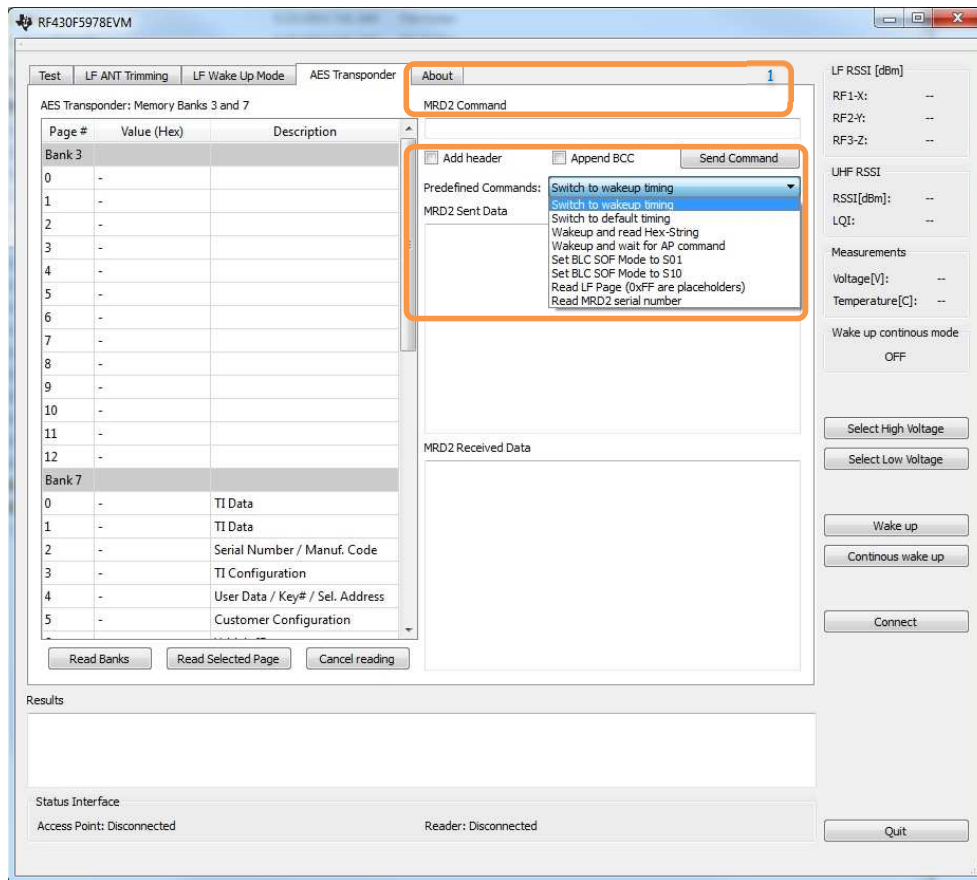


Figure 15. RF430F5978EVM AES Transponder Tab 2

1. MRD2 Command:

User input interface for setup direct hex commands

Example: Set default timing "BLC (Automotive) Timing (Command 0x0D)"
 01 12 83 0D 00 AA 01 CC 00 AA 00 E6 00 AA 01 5E 00 AA 02 44 AE

Detailed Information in Microreader RI-STU-MRD2 Reference Guide ([scbu049](#)). (See Section 6.4.3.14)

2. Predefined Commands:

Switch to wake up timing: "Special wake up timing (Command 0x0D)"
 01 12 83 0D 00 AA 03 E8 00 AA 00 FA 00 AA 02 8A 00 AA 27 10 32

SOFFoff	170 μ s
SOFFon	1000 μ s
toffLow	170 μ s
tonLow	250 μ s
toffHigh	170 μ s
tonHigh	650 μ s
EOFFoff	170 μ s
EOFFon	10000 μ s

Switch to default timing: "BLC (Automotive) Timing (Command 0x0D)"
 01 12 83 0D 00 AA 01 CC 00 AA 00 E6 00 AA 01 5E 00 AA 02 44 AE

Wakeup and read Hex-String: "Send wakeup pattern A" Send Command:
01 08 C8 A0 00 00 01 08 48 0D 2C

Receive data: 01 02 20 00 22 (Example)

For detailed information, see the *RF430F59xx Family User's Guide* ([SLAU378](#)) in the section "Low-Frequency Wake-Up Receiver".

Wakeup and wait for AP command: "Send wakeup pattern A and setup the RF430F5978EVM module at UHF interface to Receive Mode"

01 08 C8 A0 00 00 01 08 88 0D EC

The RF430F5978EVM module is waiting for commands from the UHF Access point

Now the user has the possibility to communicate with own UHF – commands

Set BLC SOF Mode to S01: "Setup Default Start of Frame HDX+" 01 03 83 25 01 A4

For detailed information, see the *Microreader RI-STU-MRD2 Reference Guide* ([SCBU049](#)).

Set BLC SOF Mode to S10: "Setup Start of Frame Burst length coding" 01 03 83 25 02 A7

For detailed information, see the *RF430F59xx Family User's Guide* ([SLAU378](#)) in the section "Low-Frequency Wake-Up Receiver".

Read LF Page: "Read Transponder Bank and page" Example: Read Bank 3 / Page 0

Send command: 01 09 C8 A0 00 00 32 10 B0 00 0E FD

Receive data: 01 10 00 80 7E 00 00 00 00 00 00 00 00 00 B1 00 6B 2F 1B

For detailed information, see the *RF430F59xx Family User's Guide* ([SLAU378](#)) in the section "LF Passive Mode Downlink Protocols".

Read MRD2 serial number: "Read the serial number of Microreader 2"

Send command: 01 02 83 03 82

Receive data: 01 08 25 F8 98 46 17 00 17 00 0B (Example)

For detailed information, see the *Microreader RI-STU-MRD2 Reference Guide* ([SCBU049](#)).

- **Add header:** Calculate the byte length and add after the start byte

For detailed information, see the *Microreader RI-STU-MRD2 Reference Guide* ([SCBU049](#)).

- **Append BCC:** The BCC Field is a one-byte value of the Longitudinal Redundancy Check calculation (XORed bytes) for the preceding message. The calculation is performed over whole command excluding the Start Byte.

For detailed information, see the *Microreader RI-STU-MRD2 Reference Guide* ([SCBU049](#)) in the section "BCC: Block Check Character".

15 UHF Configuration Settings

Deviation	=	31.738281
Base frequency	=	433.92 MHz
Carrier frequency	=	433.92 MHz
Channel number	=	0
Modulated	=	true
Modulation format	=	2-GFSK
Manchester enable	=	false
Sync word qualifier mode	=	30/32 sync word bits detected
Preamble count	=	4
Channel spacing	=	199.951172 kHz
Data rate	=	76.767 kBaud
RX filter BW	=	232.142857 kHz
Data format	=	Normal mode
CRC enable	=	true
Whitening	=	false
Device address	=	0
Address config	=	No address check
CRC autoflush	=	false
PA ramping	=	false
TX power	=	-20 dBm ⁽¹⁾

⁽¹⁾ RF430F5978EVM power condition meets the FCC 5.231 requirements

16 Configuration Software for UHF block

The RF430F5978 can be configured by using the SmartRF™ Studio software ([SWRC046](#)). Because RF430F5978 selection is not available, CC430 and CC1101 settings must be selected in SmartRF Studio. The SmartRF Studio software is highly recommended for obtaining optimum register settings, and for evaluating performance and functionality.

For information on SmartRF Studio, see the web site at <http://www.ti.com/tool/smarterftm-studio>.

17 RF430F5978EVM Hardware Description

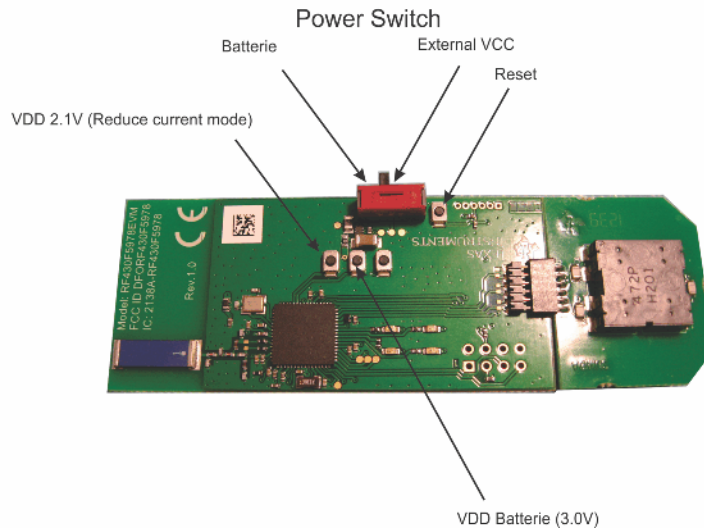
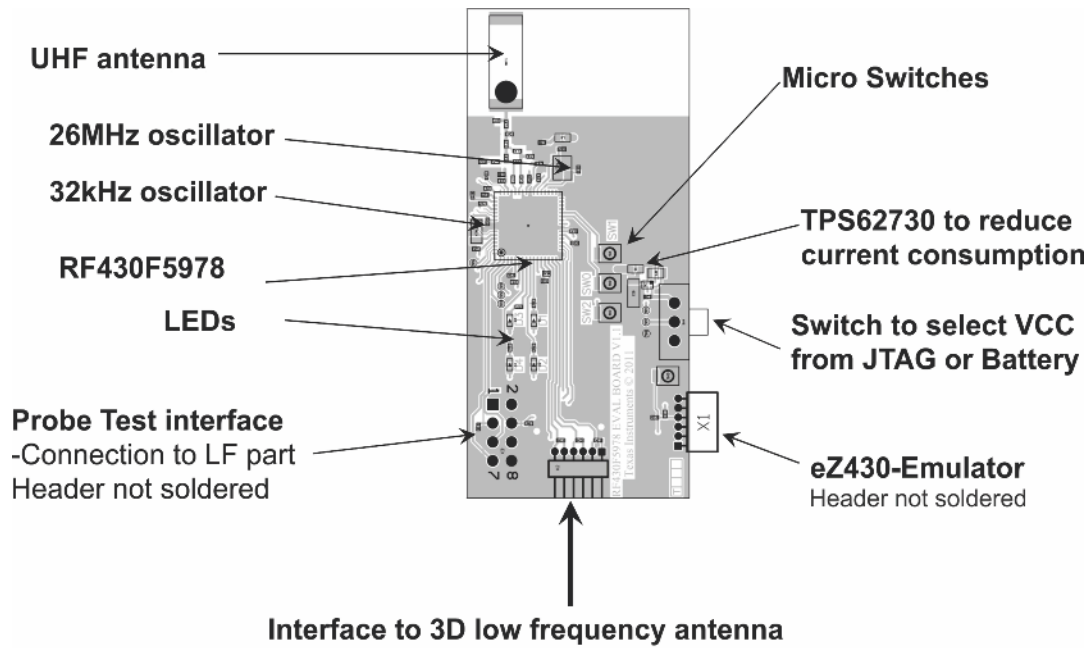


Figure 16. RF430F5978EVM Module

18 Programming Hardware Interface

18.1 Required Adapter for Programming Interface

The kit includes a JTAG/SBW adapter and a 4-pin connector for firmware change of the RF430F5978EVM module or AP434R01 module.

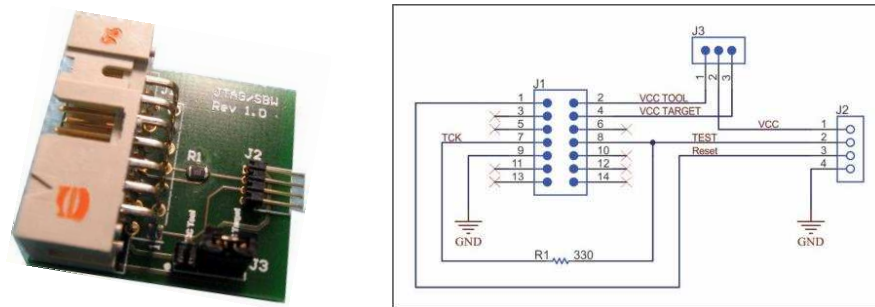


Figure 17. JTAG/SBW Adapter Schematic



Figure 18. 4-Pin Connector

18.2 Required Equipment to Program the RF430F5978EVM and AP434R01 Modules

The MSP-FET430UIF or MSP-FET Flash Emulation Tool (<http://www.ti.com/tool/msp-fet>) is needed to program the modules.



Figure 19. MSP-FET430UIF



Figure 20. MSP-FET

18.3 RF430F5978EVM Hardware Connection for Programming With FET Tool

1. Connect JTAG cable to MSP430 FET UIF or MSP-FET Tool and JTAG/SBW adapter.
2. Connect the 4-pin connector to JTAG/SBW adapter.
3. Connect the 4-pin connector to the RF430F5978 SBW pins on the RF430F5978EVM top layer and place the 4-pins in central position (see [Figure 21](#)).

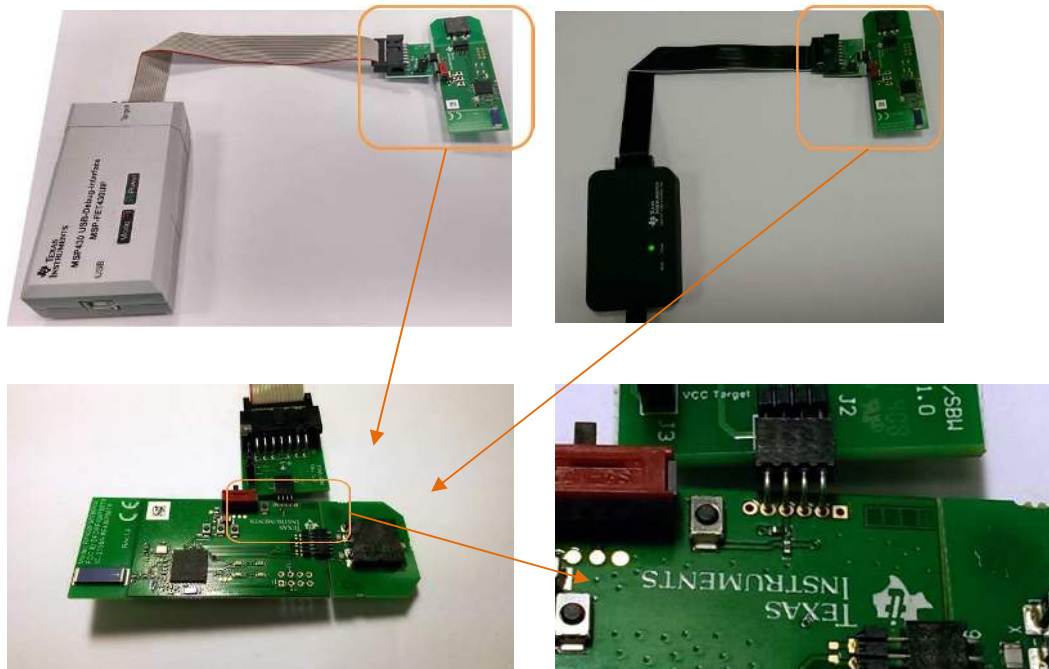


Figure 21. Connect FET Tool to RF430F5978EVM Module

18.4 Access Point AP434R01 hardware based on MSP430F5509 MCU and CC1101 Transceiver

Additional device-specific information can be found on the MSP430 web site (www.ti.com/msp430) and on the Wireless Connectivity web site (www.ti.com/product/cc1101)

18.5 AP434R01 Hardware Connection for Programming With MSP FET Tool

1. Connect the JTAG cable to the MSP430FETUIF or the MSP-FET tool and JTAG/SBW adapter.
2. Connect the 4-pin connector to the JTAG/SBW adapter.
3. Connect the 4-pin connector to AP434R01 SBW pins from AP434R01 bottom layer (see [Figure 22](#)).

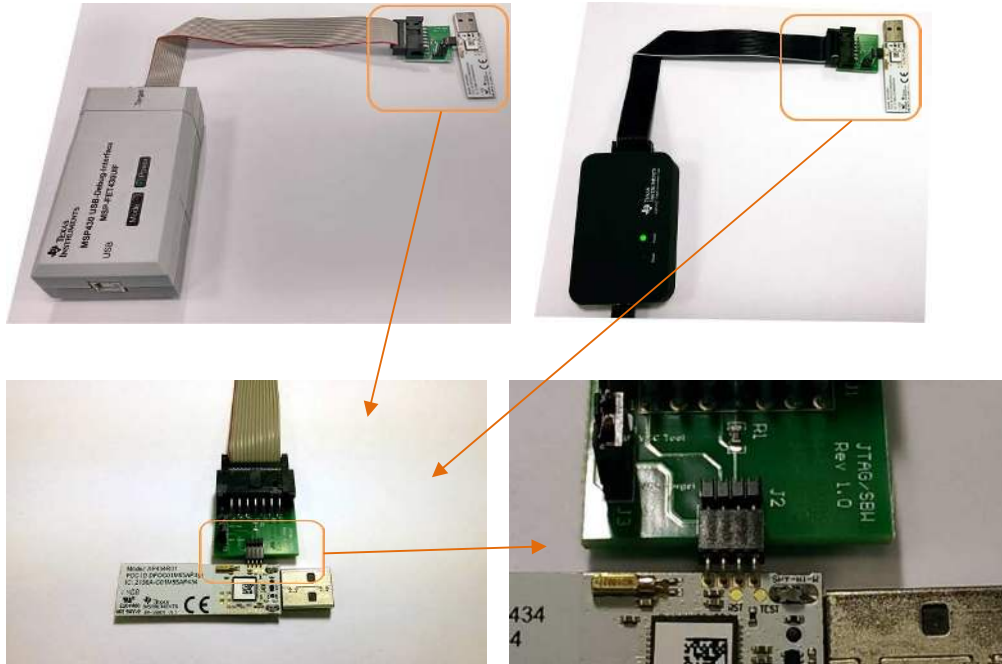


Figure 22. Connect FET Tool to AP434R01 Module

19 Professional Software Development Tools

Code Composer Studio™ IDE ([CCSTUDIO](#))

IAR Embedded Workbench ([IAR-KICKSTART](#))

For more information, see the TI web site at http://www.ti.com/lscs/ti/microcontrollers_16-bit_32-bit/msp/tools_software.page

20 Schematics

20.1 RF430F5978EVM

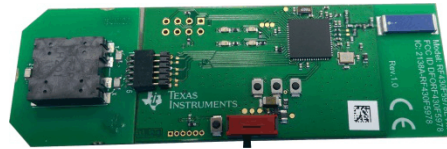


Figure 23. RF430F5978EVM Photo

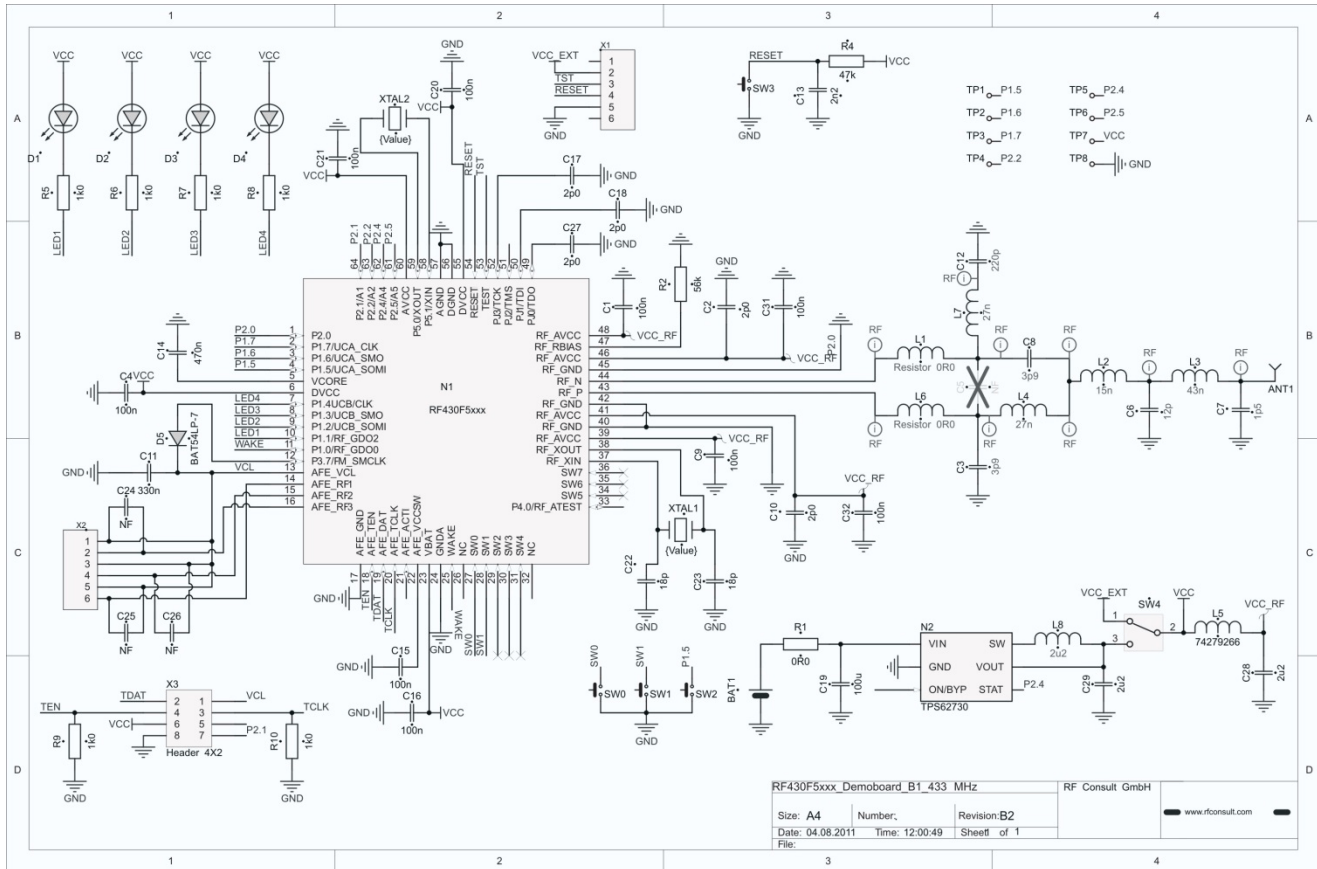


Figure 24. RF430F5978EVM Module Schematic

20.2 LF 3D Antenna

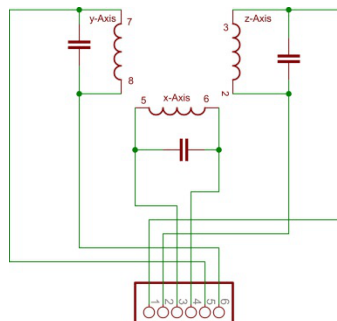


Figure 25. LF 3D Antenna Schematic

20.3 APA434R01



Figure 26. APA434R01 Photo

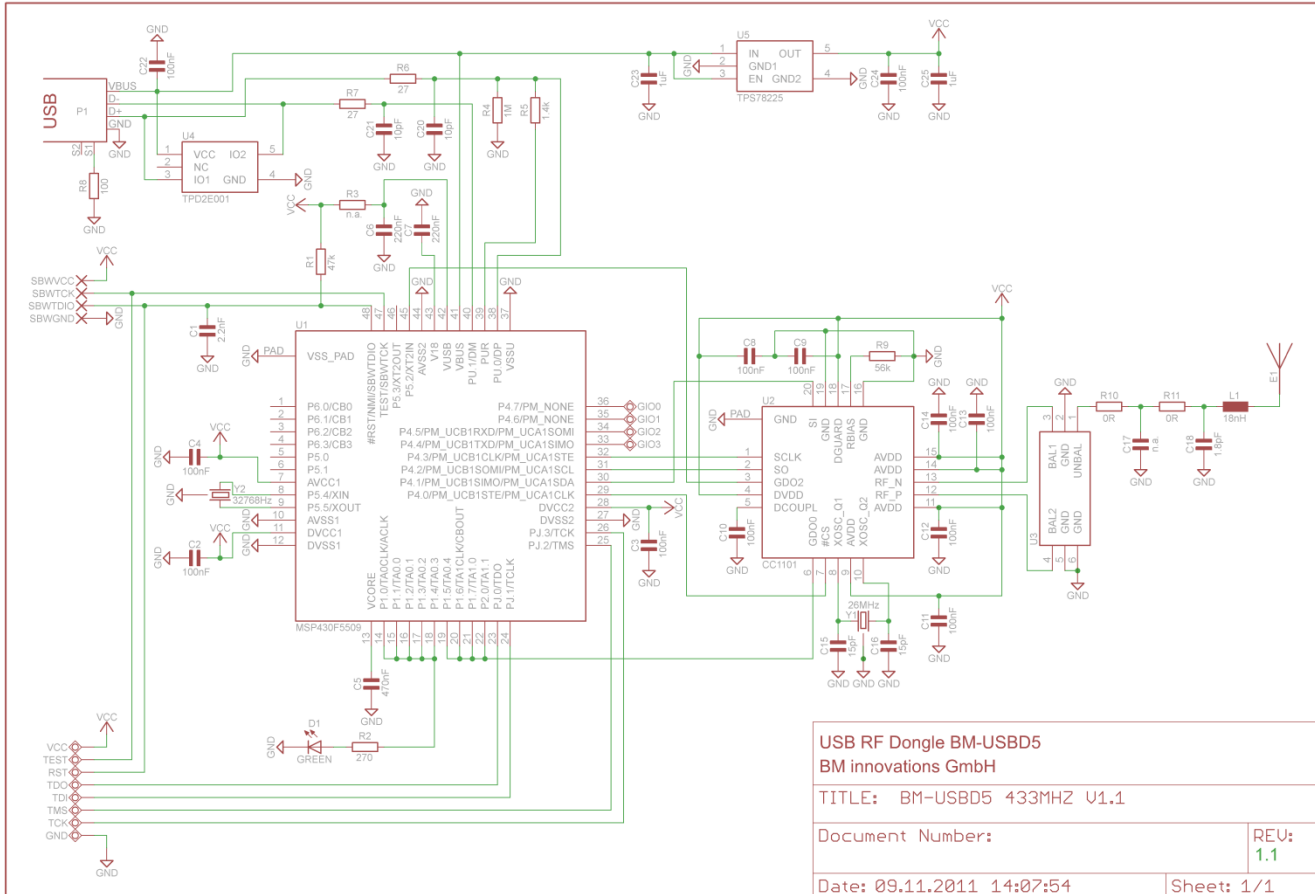


Figure 27. AP434R01 Module Schematic

20.4 MRD2EVM (Microreader LF 134.2 kHz)

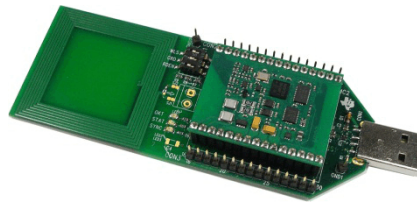


Figure 28. MRD2EVM Photo

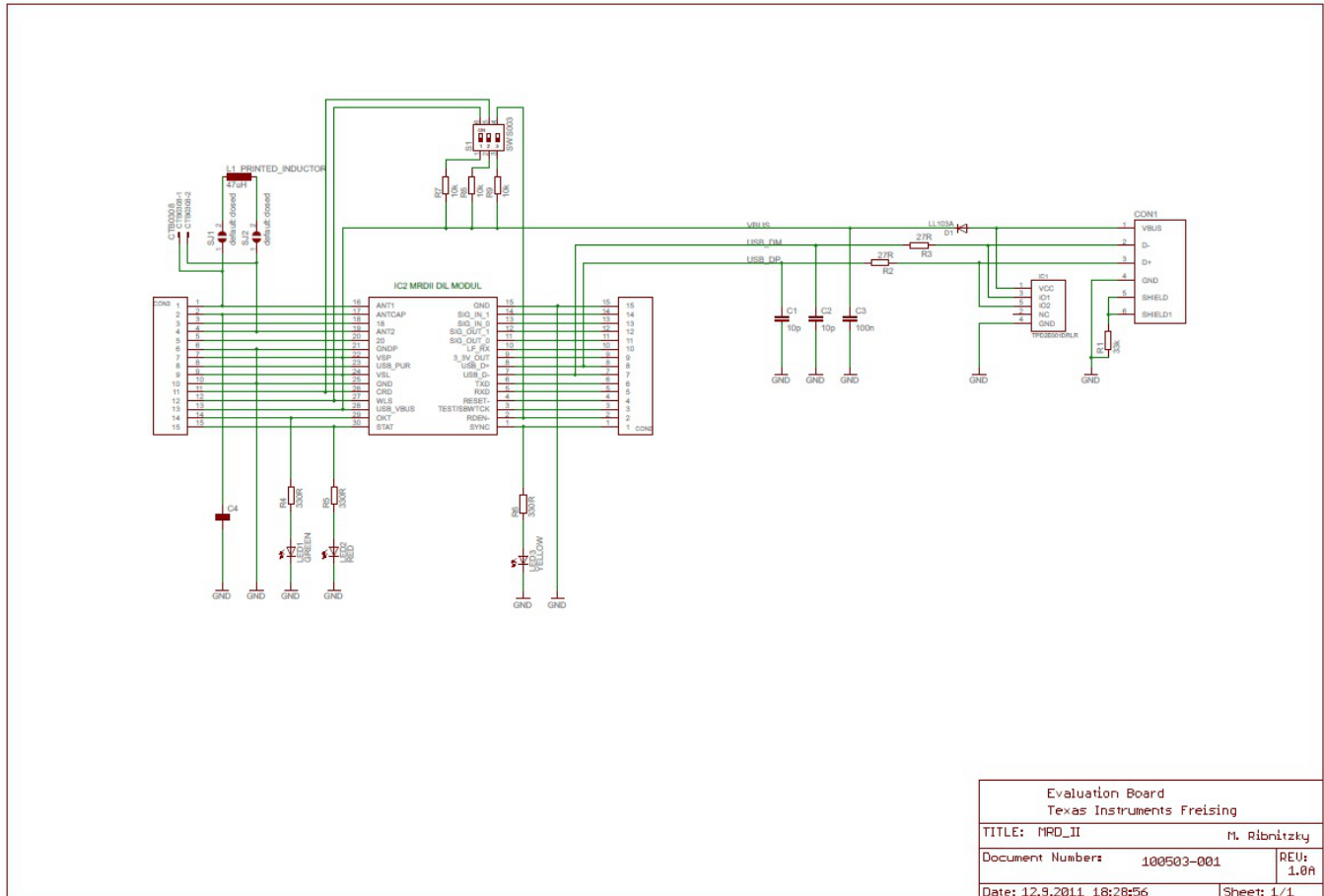


Figure 29. MRD 2 Schematic

For additional documents, such as the Microreader Evaluation Kit description and user guide, go to <http://www.ti.com/tool/mrd2evm>.

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CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

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http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page

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If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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